To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

SILICON TRANSISTOR
2SD2403

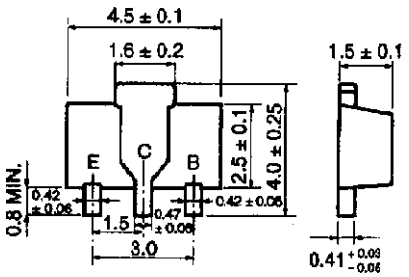
NPN SILICON EPITAXIAL TRANSISTOR
FOR LOW-FREQUENCY POWER AMPLIFIERS AND MID-SPEED SWITCHING

The 2SD2403 is a transistor featuring high current capacitance in small dimension. This transistor is ideal for DC/DC converters and motor drivers.

FEATURES

- High current capacitance
- Low collector saturation voltage
- Complementary transistor with 2SB1572

PACKAGE DRAWING (UNIT: mm)



Electrode Connection

E : Emitter
C : Collector(Fin)
B : Base

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	V_{CBO}		80	V
Collector to emitter voltage	V_{CEO}		60	V
Emitter to base voltage	V_{EBO}		6.0	V
Collector current (DC)	$I_{C(DC)}$		3.0	A
Collector current (pulse)	$I_{C(pulse)}$	PW ≤ 10 ms duty cycle ≤ 50 %	5.0	A
Base current (DC)	$I_{B(DC)}$		0.2	A
Base current (pulse)	$I_{B(pulse)}$	PW ≤ 10 ms duty cycle ≤ 50 %	0.4	A
Total power dissipation	P_T	16 cm^2 × 0.7 mm ceramic board mounted	2.0	W
Junction temperature	T_j		150	°C
Storage temperature	T_{stg}		−55 to +150	°C

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	I_{CBO}	V_{CB} = 80 V, I_E = 0			100	nA
Emitter cutoff current	I_{EBO}	V_{EB} = 6.0 V, I_C = 0			100	nA
DC current gain	h_{FE1}	V_{CE} = 2.0 V, I_C = 0.1 A	80			–
DC current gain	h_{FE2}	V_{CE} = 2.0 V, I_C = 1.0 A	100	200	400	–
DC base voltage	V_{BE}	V_{CE} = 2.0 V, I_C = 0.1 A	630	670	730	mV
Collector saturation voltage	$V_{CE(sat)1}$	I_C = 2.0 A, I_B = 0.1 A		150	300	mV
Collector saturation voltage	$V_{CE(sat)2}$	I_C = 3.0 A, I_B = 0.15 A		210	500	mV
Base saturation voltage	$V_{BE(sat)}$	I_C = 2.0 A, I_B = 0.1 A		0.89	1.2	V
Gain bandwidth product	f_T	V_{CE} = 10 V, I_E = –0.3 A		130		MHz
Output capacitance	C_{ob}	V_{CB} = 10 V, I_E = 0, f = 1 MHz		30		pF
Turn-on time	t_{on}	I_C = 1.0 A, V_{CC}= 10 V I_{B1} = –I_{B2} = 0.1 A R_L = 5.0 Ω		150		ns
Storage time	t_{stg}			652		ns
Fall time	t_f			40		ns

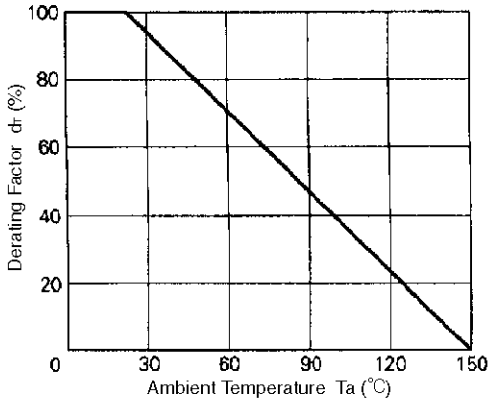
h_{FE} CLASSIFICATION

Marking	GX	GY	GZ
h_{FE2}	100 to 200	160 to 320	200 to 400

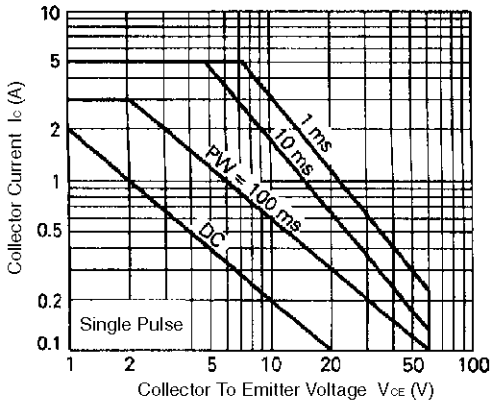
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TYPICAL CHARACTERISTICS (Ta = 25°C)

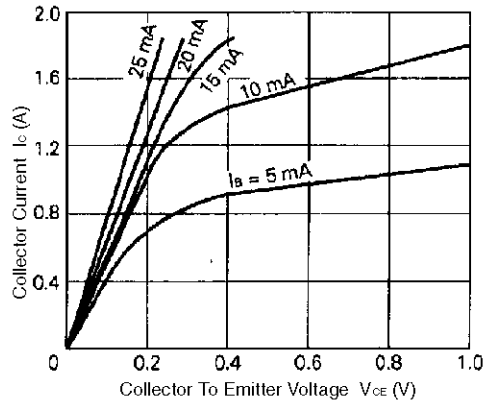
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



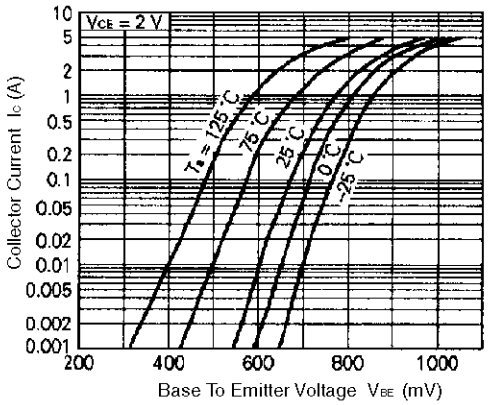
FORWARD BIAS SAFE OPERATING AREA



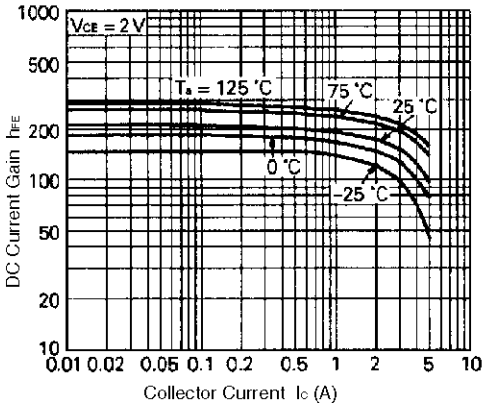
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



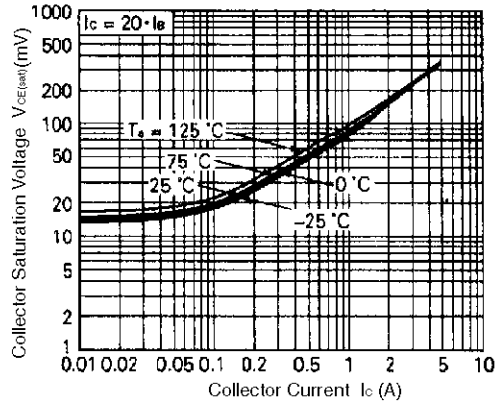
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



DC CURRENT GAIN vs. COLLECTOR CURRENT

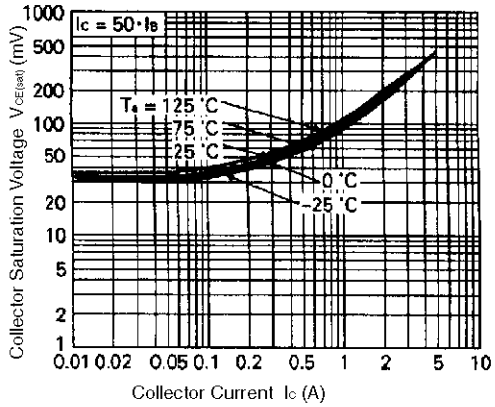


COLLECTOR SATURATION VOLTAGE vs. COLLECTOR CURRENT

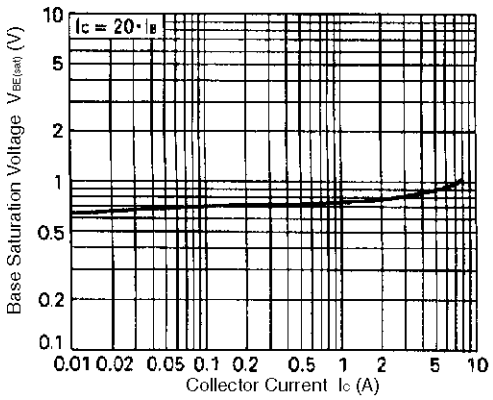


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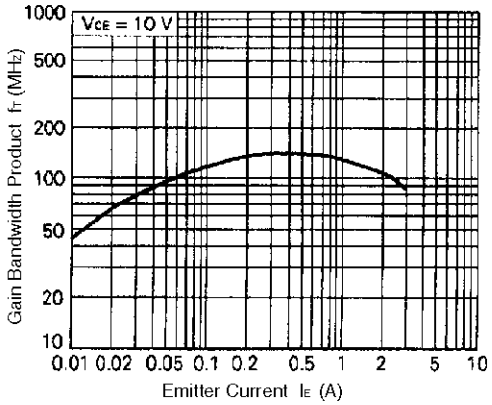
COLLECTOR SATURATION VOLTAGE vs. COLLECTOR CURRENT



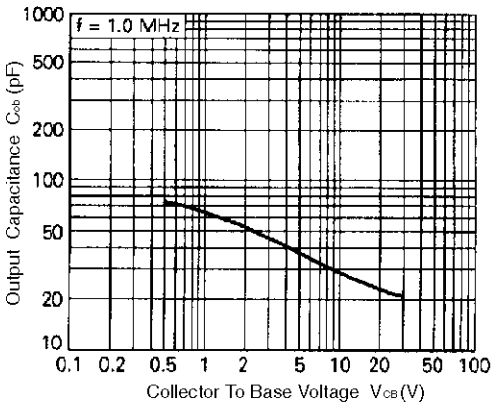
BASE SATURATION VOLTAGE vs. COLLECTOR CURRENT



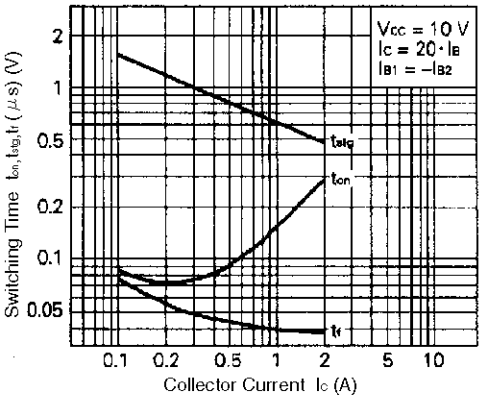
GAIN BANDWIDTH PRODUCT vs. EMITTER CURRENT



OUTPUT CAPACITANCE vs. REVERSE VOLTAGE



SWITCHING CHARACTERISTICS



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